

STM32WBA Nucleo-64 board (MB1801 and MB2293)

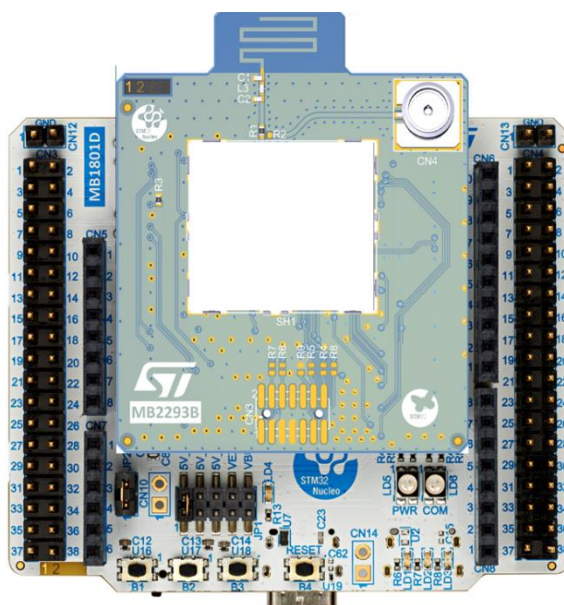
Introduction

The **NUCLEO-WBA25CE1** STM32 Nucleo-64 board, based on the MB1801 mezzanine board and the MB2293 MCU RF board, is a wireless and ultra-low-power board embedding a powerful and ultra-low-power radio compliant with the Bluetooth® LE, IEEE 802.15.4-2015 PHY and MAC, supporting Thread, Matter, and Zigbee®.

A user USB Type-C® is also provided for easy connection with other devices.

The ARDUINO® Uno V3 connectivity support and the ST morpho headers allow the easy expansion of the functionality of the STM32 Nucleo open development platform with a wide choice of specialized shields.

Figure 1. NUCLEO-WBA25CE1 global view



Picture is not contractual.



1 Features

- Ultra-low-power wireless [STM32WBA25CEU7](#) microcontroller based on the Arm® Cortex®-M33 core, featuring 512 Kbytes of flash memory and 96 Kbytes of SRAM in a UFQFPN48 package
- MCU RF board (MB2293):
 - 2.4 GHz RF transceiver supporting Bluetooth® LE specification v6.0
 - Build-in PCB antenna
- Three user LEDs
- Three user push-buttons and one reset push-button
- Board connectors:
 - User USB Type-C®
 - USB Type-C® for debugging purpose
 - ARDUINO® Uno V3 expansion connector
 - ST morpho headers for full access to all STM32 I/Os
- Flexible power-supply options: ST-LINK USB V_{BUS} or external sources
- On-board STLINK-V3EC debugger/programmer with USB re-enumeration capability: mass storage, Virtual COM port, and debug port
- Comprehensive free software libraries and examples available with the [STM32CubeWBA](#) MCU Package
- Support of a wide choice of Integrated Development Environments (IDEs) including IAR Embedded Workbench®, MDK-ARM, and STM32CubeIDE

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2 Ordering information

To order the NUCLEO-WBA25CE1 board, refer to [Table 1](#). Additional information is available from the datasheet and reference manual of the target microcontroller.

Table 1. List of available products

Order code	Board reference	Target STM32
NUCLEO-WBA25CE1	- MB1801⁽¹⁾ - MB2293⁽²⁾	STM32WBA25CEU7

1. Mezzanine board

2. MCU RF board

2.1 Codification

The meaning of the codification is explained in [Table 2](#).

Table 2. Codification explanation

NUCLEO-XXXYYZTU	Description	Example: NUCLEO-WBA25CE1
XXX	MCU series in STM32 32-bit Arm Cortex MCUs	STM32WBA series
YY	MCU product line in the series	STM32WBA25 product line
Z	STM32 package pin count: C for 48 pins	48 pins
T	STM32 flash memory size: E for 512 Kbytes	512 Kbytes
U	1 for Cut1.0	First version of NUCLEO-WBA25

3 Development environment

3.1 System requirements

- Multi-OS support: Windows® 10, Linux® 64-bit, or macOS®
- USB Type-A or USB Type-C® to USB Type-C® cable

Note: macOS® is a trademark of Apple Inc., registered in the U.S. and other countries and regions.
Linux® is a registered trademark of Linus Torvalds.
Windows is a trademark of the Microsoft group of companies.

3.2 Development toolchains

- IAR Systems® - IAR Embedded Workbench®⁽¹⁾
- Keil® - MDK-ARM⁽¹⁾
- STMicroelectronics - STM32CubeIDE

1. On Windows® only.

3.3 Demonstration software

The demonstration software, included in the STM32Cube MCU Package corresponding to the on-board microcontroller, is preloaded in the STM32 flash memory for easy demonstration of the device peripherals in standalone mode. The latest versions of the demonstration source code and associated documentation can be downloaded from www.st.com.

3.4 CAD resources

All board design resources, including schematics, CAD databases, manufacturing files, and the bill of materials, are available from the [NUCLEO-WBA25CE1](http://www.st.com) product page at www.st.com.

4 Conventions

Table 3 provides the conventions used for the ON and OFF settings in the present document.

Table 3. ON/OFF convention

Convention	Definition
Jumper JPx ON	Jumper fitted
Jumper JPx OFF	Jumper not fitted
Jumper JPx [1-2]	Jumper fitted between pin 1 and pin 2
Solder bridge SBx ON	SBx connections closed by 0 Ω resistor
Solder bridge SBx OFF	SBx connections left open
Resistor Rx ON	Resistor soldered
Resistor Rx OFF	Resistor not soldered
Capacitor Cx ON	Capacitor soldered
Capacitor Cx OFF	Capacitor not soldered

5 Safety recommendations

5.1 Targeted audience

This product targets users with at least basic electronics or embedded software development knowledge such as engineers, technicians, or students. This board is not a toy and is not suited for use by children.

5.2 Handling the board

This product contains a bare printed circuit board and like all products of this type, the user must be careful about the following points:

- The connection pins on the board might be sharp. Be careful when handling the board to avoid hurting yourself
- This board contains static-sensitive devices. To avoid damaging it, handle the board in an ESD-proof environment.
- While powered, do not touch the electric connections on the board with your fingers or anything conductive. The board operates at a voltage level that is not dangerous, but components might be damaged when shorted.
- Do not put any liquid on the board and avoid operating the board close to water or at a high humidity level.
- Do not operate the board if dirty or dusty.

6 Quick start

This section describes how to start development quickly using NUCLEO-WBA25CE1.

To use the product, you must accept the evaluation product license agreement from the www.st.com/epl webpage.

Before the first use, make sure that no damage occurred to the board during shipment:

- All socketed components must be firmly secured in their sockets.
- Nothing must be loose in the board blister.

The Nucleo board is an easy-to-use development kit to evaluate quickly and start development with an STM32 microcontroller in a UFQFPN48 package.

6.1 Getting started

Follow the sequence below to configure the NUCLEO-WBA25CE1 board and launch the demonstration application (refer to [Figure 3](#) and [Figure 4](#) for component location):

1. Check jumper positions on board: JP2 ON, JP1 on 5V_STLK.
2. Check that the power switch (SW1) is in the default position.
3. Install the ST Bluetooth® LE sensor mobile application on a Bluetooth® LE compatible mobile device from the App Store or Google Play.
4. Connect the Nucleo board to a PC with a USB Type-A or USB Type-C® to USB Type-C® cable through the USB_STLK USB connector (CN15).
5. Use the ST Bluetooth® LE sensor mobile application to detect the STM32WBA P2P server (P2PSRV) and connect it. The smartphone application displays the service and characteristics of the device.
6. Pushing the button (B1) on the board toggles the alarm on the smartphone display. On the smartphone, push the lamp to switch ON/OFF the Nucleo board blue LED (LD1).

7 Hardware layout and configuration

NUCLEO-WBA25CE1 is designed around the STM32WBA25CE. The design includes a mezzanine board and an MCU RF board. The hardware block diagram in Figure 2 illustrates the connection between STM32WBA25CE and peripherals (ARDUINO® Uno V3 connectors, ST morpho connector, and embedded ST-LINK).

Figure 3 and Figure 4 help users locate these features on the NUCLEO-WBA25CE1 board. The mechanical dimensions of the NUCLEO-WBA25CE1 product are shown in Figure 5 and Figure 6.

Figure 2. Hardware block diagram

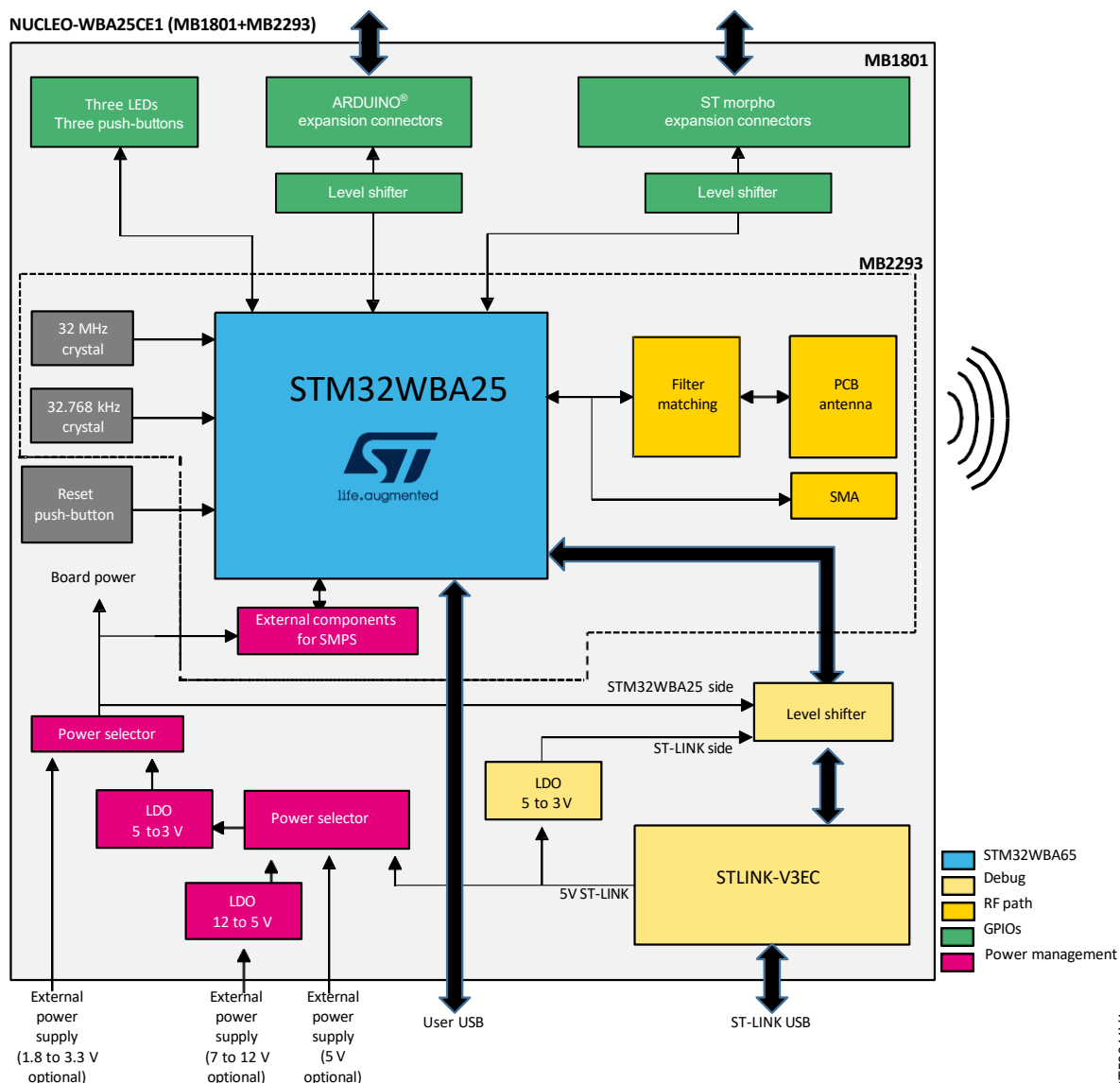
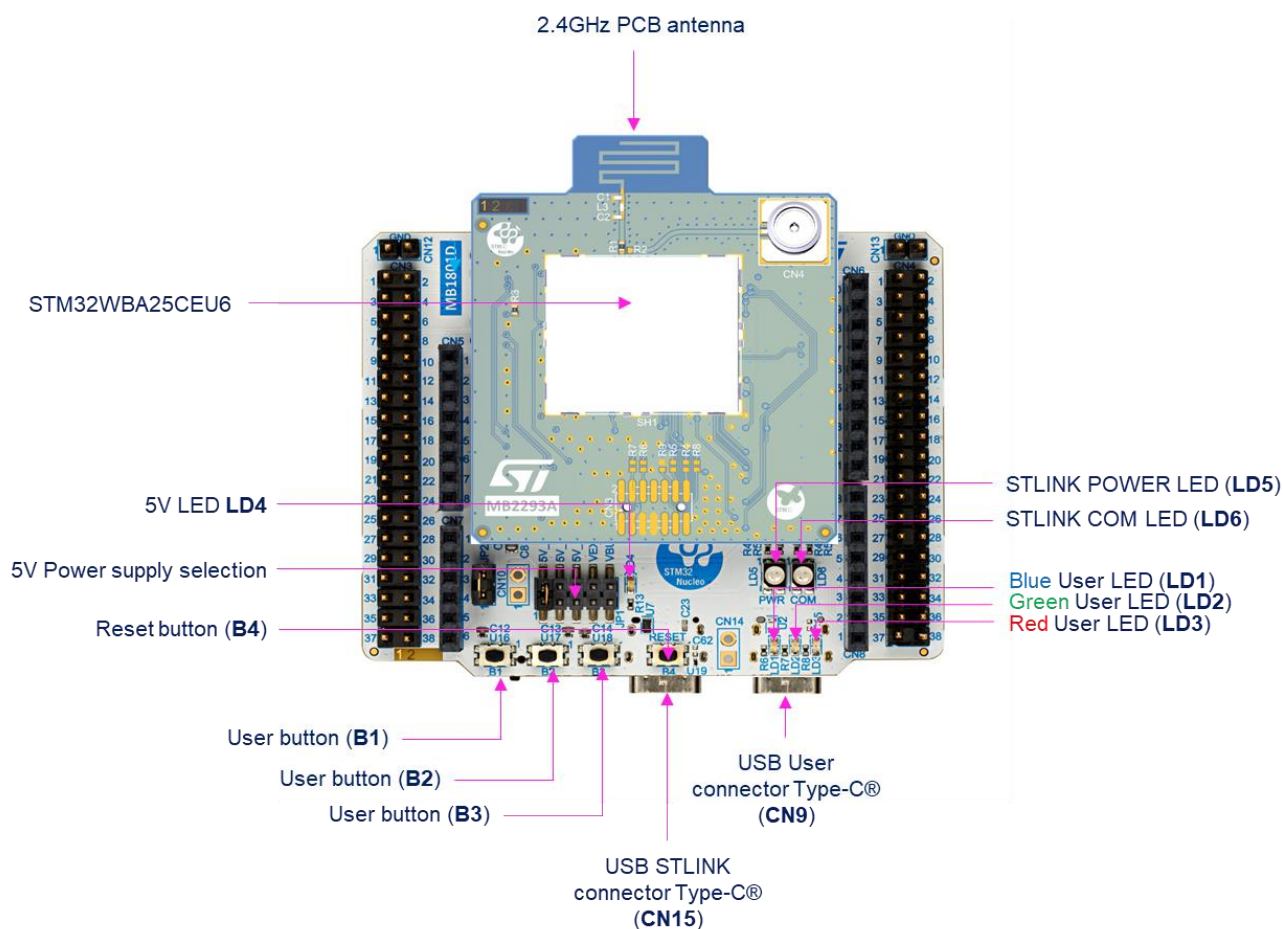
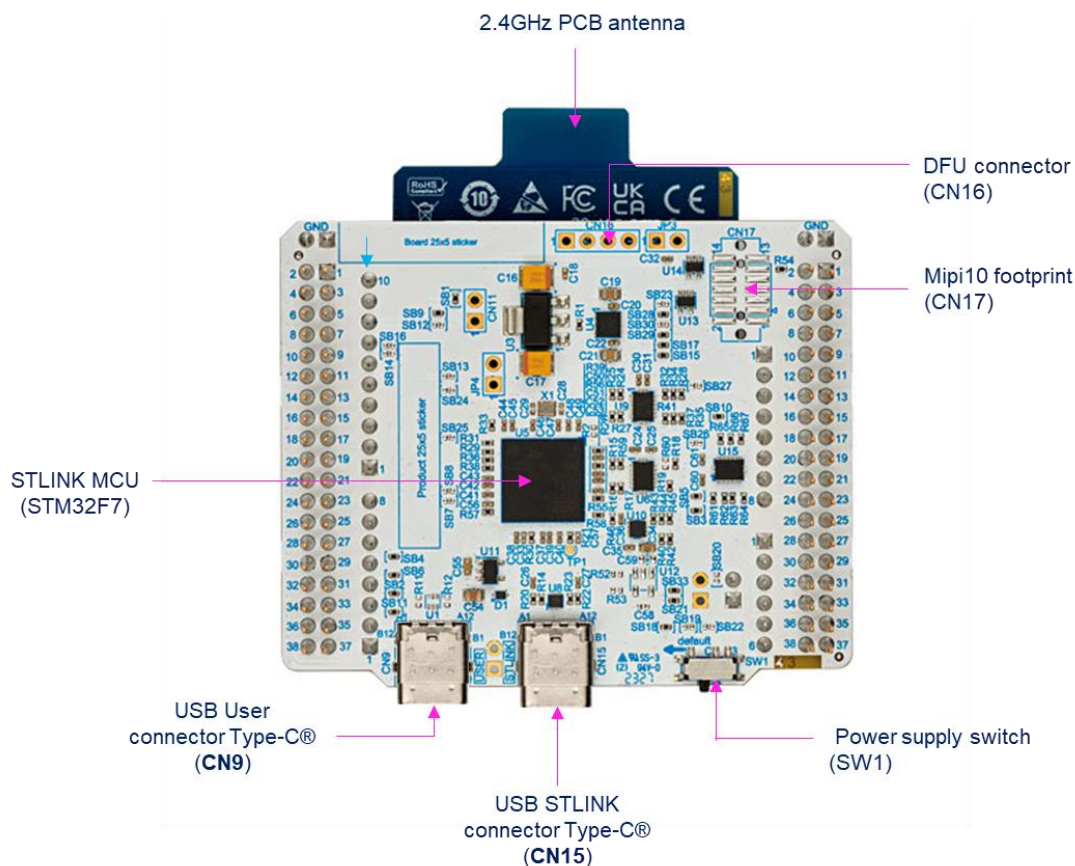


Figure 3. NUCLEO-WBA25CE1 PCB top view



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Figure 4. NUCLEO-WBA25CE1 PCB bottom view



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Figure 5. NUCLEO-WBA25CE1 (MB1801) mechanical dimensions (in millimeters)

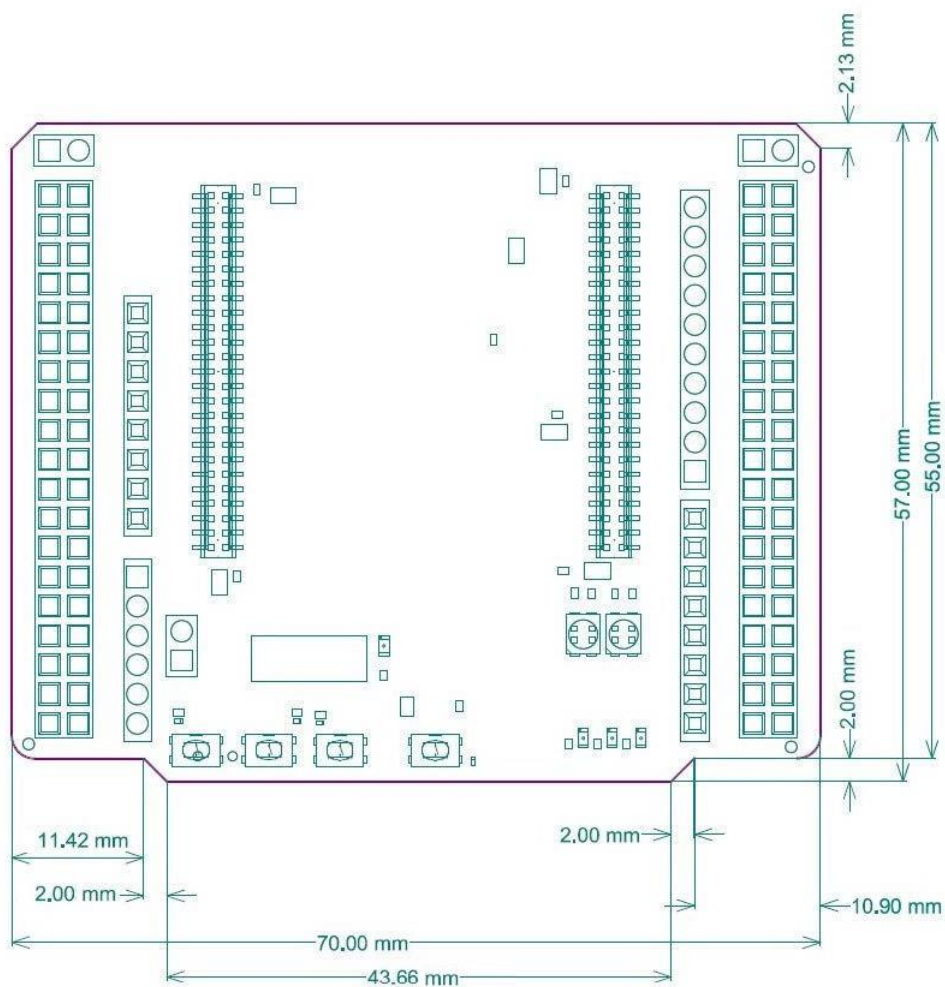
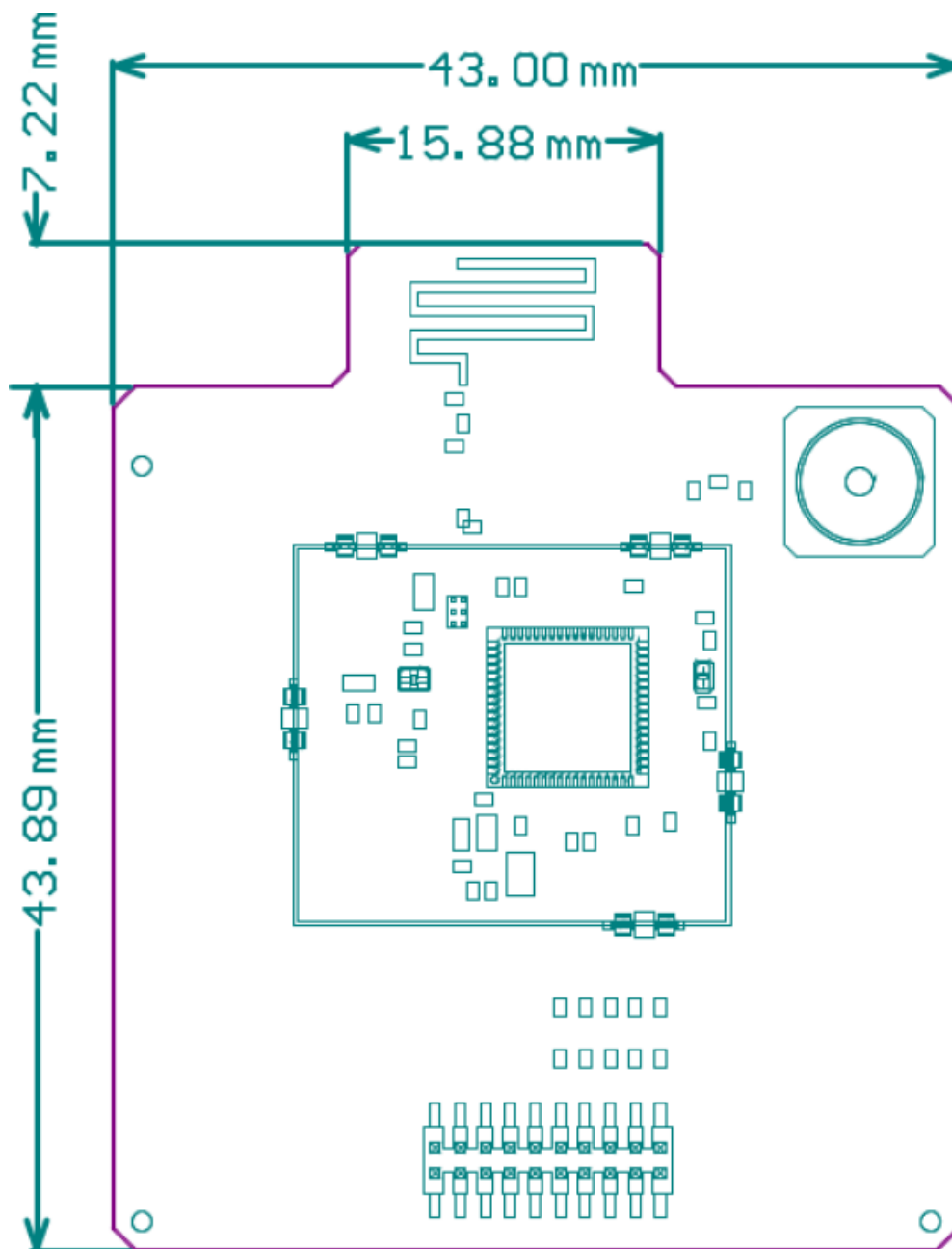


Figure 6. NUCLEO-WBA25CE1 (MB2293) mechanical dimensions (in millimeters)



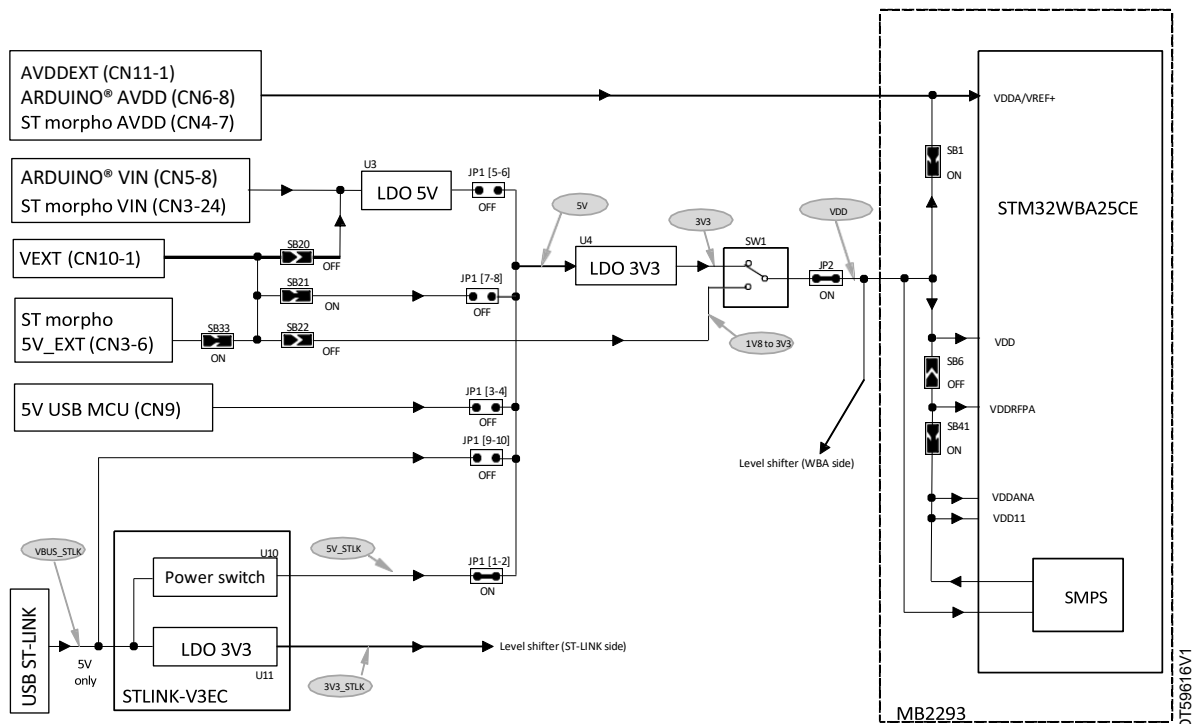
7.1 Power supply

7.1.1 General description

By default, the STM32WBA25CE embedded on this Nucleo board is supplied by 3V3 but the board proposes many possibilities to supply the module. In fact, at first, the 3V3 can come from ST-LINK USB, ARDUINO®, or ST morpho connectors. Moreover, STM32WBA25CE can be supplied by an external source (between 1.8 and 3.3 V). Thanks to level shifters, debugging by embedded ST-LINK is always possible even if the supply voltage of the target is different than 3V3 (ST-LINK supply). **Figure 7** shows the power tree. Moreover, this figure also shows the default state of the jumpers and the solder bridges.

Note: *The product must be supplied by a voltage source or auxiliary equipment that complies with EN 62368-1:2014+A11:2017 or the standard that replaces it. It must also be a safety extralow voltage (SELV) with limited power capability.*

Figure 7. STM32WBA25CE1 power tree



7.1.2 7 to 12 V power supply

A 7 to 12 V DC power source can power NUCLEO-WBA25CE1. There are three accesses for this type of level:

- Pin VIN of the ARDUINO® connector (CN5-8). It is possible to apply until +12 V on this pin or use an ARDUINO® shield, which can deliver this type of voltage on the VIN pin.
- Pin VIN of the ST morpho connector (CN3-24). It is possible to apply until +12 V on this pin like for the ARDUINO® connection.
- External input (CN10). Be careful, in this case, the states of the jumpers and solder bridge are critical. Verify these states in [Table 4](#).

These sources are connected to a linear low-drop voltage regulator (U2). The output of this regulator (5 V) is a potential source of the 5V signal (refer to details in the next section).

7.1.3 5 V power supply

A 5 V DC power source can power NUCLEO-WBA25CE1. The 5 V can come from several connectors:

- External input (VEXT, CN10). Be careful, in this case, the states of the jumpers and solder bridge are critical. Refer to [Table 4](#).
- 5V_EXT from ST morpho connector (CN3-6 of MB1801)
- VIN (7-12 V) input through the voltage regulator (U2). Refer to [Section 7.1.2: 7 to 12 V power supply](#).
- USB ST-LINK can supply the board directly (VBUS_STLK) or through the monitoring of STLINK-V3EC.
- 5V_USB coming from the user USB connector (CN9).

The jumper (JP1) selects the 5V source. [Table 4](#) shows the configuration to apply the selected source.

Depending on the current needed on the devices connected to the USB port, and the board itself, power limitations can prevent the system from working as expected. The user must ensure that NUCLEO-WBA25CE1 is supplied with the correct power source depending on the current need.

Table 4. Power supply selector (JP1) description

Jumper	Setting	Configuration
JP1 5V supply source selector	5V sources 5V_STLK 5V_USB 5V_INT VEXT VBUS_STLK 2 10 1 9 JP1	Default setting NUCLEO-WBA25CE1 is supplied through the USB ST-LINK USB Type-C® connector (CN15). ST-LINK controls this source. It enables this 5V after the startup of STLINK-V3EC if all the conditions are fulfilled.
	5V sources 5V_STLK 5V_USB 5V_INT VEXT VBUS_STLK 2 10 1 9 JP1	NUCLEO-WBA25CE1 is supplied through the user USB Type-C® connector (CN9).
	5V sources 5V_STLK 5V_USB 5V_INT VEXT VBUS_STLK 2 10 1 9 JP1	NUCLEO-WBA25CE1 is supplied through pin 8 of the ARDUINO® connector (CN5) or pin 24 of the ST morpho connector (CN3) or CN10 (refer to the configuration details in the present Power supply section).
	5V sources 5V_STLK 5V_USB 5V_INT VEXT VBUS_STLK 2 10 1 9 JP1	NUCLEO-WBA25CE1 is supplied through CN10 or through pin 6 of the ST morpho connector (CN3). Refer to the configuration details in the present Power supply section.
	5V sources 5V_STLK 5V_USB 5V_INT VEXT VBUS_STLK 2 10 1 9 JP1	NUCLEO-WBA25CE1 is supplied through the ST- LINK USB Type-C® connector (CN15) without any control from STLINK-V3EC.

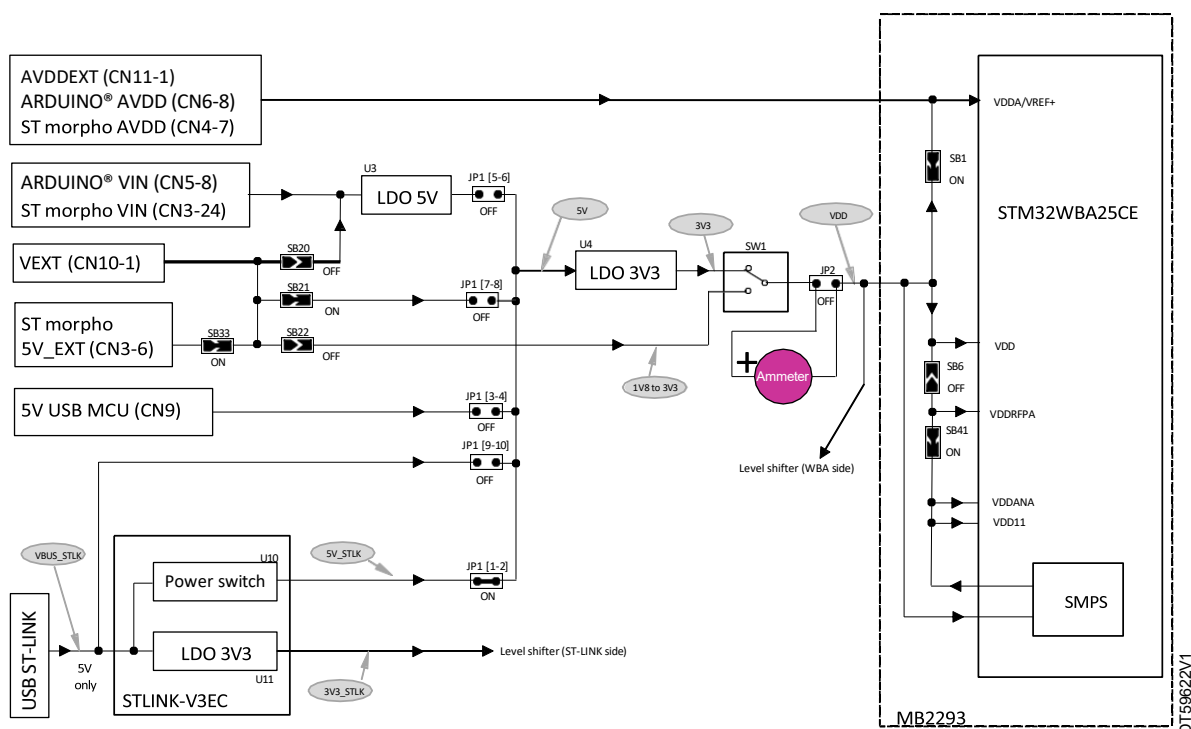
When 5V_STLK is used, JP1 is set to [1-2]. The sequence is specific. In the beginning, only STLINK-V3EC is supplied. If the USB enumeration succeeds, the 5V_STLK power is enabled by asserting the PWR_EN signal from STLINK-V3EC. This pin is connected to a power switch (U10), which supplies the rest of the board. This power switch also features a current limitation to protect the PC in case of currents exceeding 300 mA.

7.1.4 Current measurement

As the device has low-power features, it can be interesting to measure the current consumed by NUCLEO-WBA25CE1. To do this measurement easily, there are two possibilities:

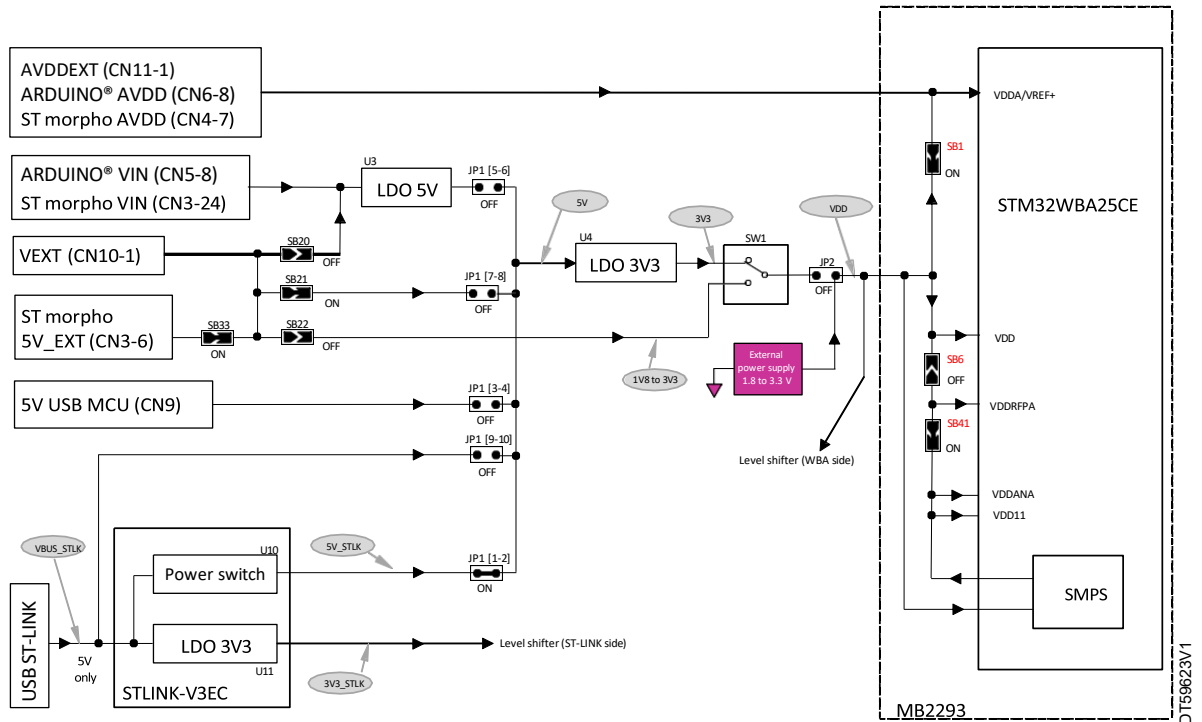
1. Measure the supply current of the SoC using an ammeter in place of the jumper (JP2). In this case, all supply sources can be used except the AVDD coming from the ARDUINO® connector. AVDD input must not be used during this measurement and **SB1** must be ON. Figure 8 shows the configuration.

Figure 8. Current measurement with an ammeter



2. Use an external power supply with current measurement capability. In this case, the jumper (JP2) must be removed and the supply connected to pin 2 of JP2 (refer to Figure 9). The supply voltage must be between 1V8 and 3V3. AVDD input must not be used and **SB1** must be ON during this measurement. You can select any source on JP1 but STM recommends the [1-2] position as there is a power switch protection.

Figure 9. Current measurement with an external power supply

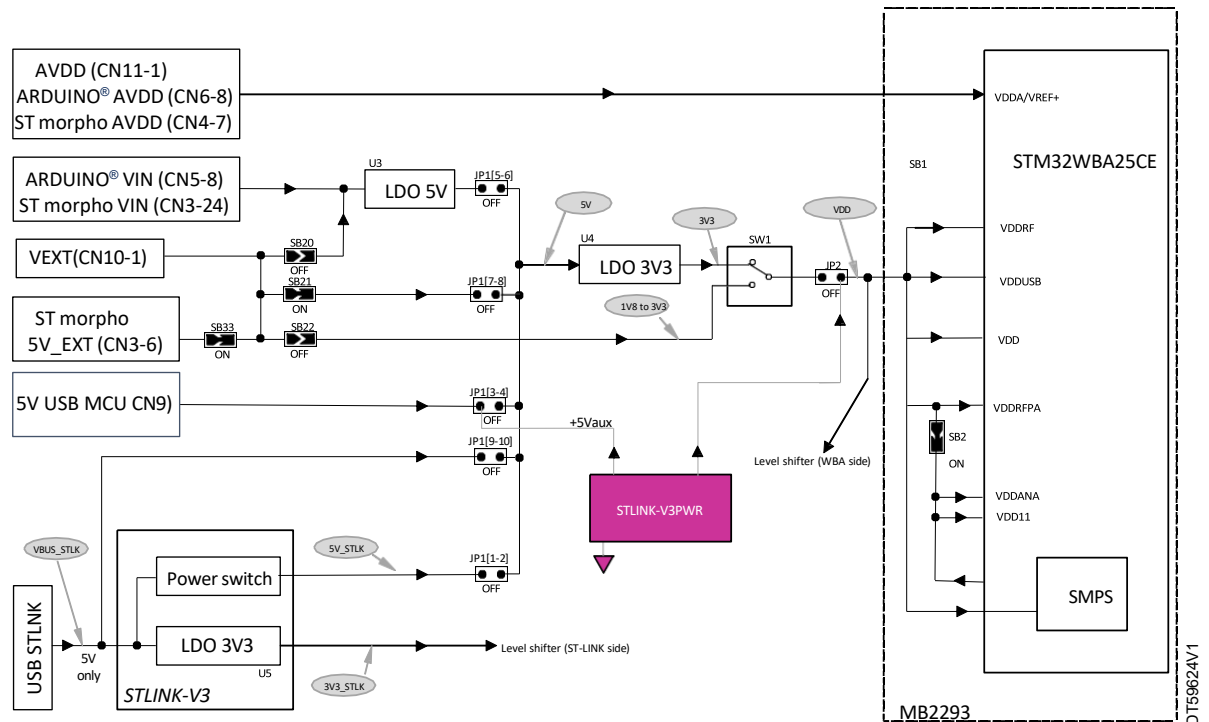


Caution: As explained above, the supply voltage VDD must be between 1.8 and 3.3 V. The limit of 3.3 V is due to level shifters (when STM32WBA25CE can support 3.6 V).

3. If it is necessary to do power consumption measurement during debugging, STMicroelectronics has an interesting solution. It is possible to use STLINK-V3PWR. This product allows two sources of supply: a first for the current measurement on the STM32WBA25CE, and a second for the rest of the board, such as LEDs. Like in the previous case, the jumper (JP2) must be removed, and the main supply for the current measurement is connected to pin 2 of JP2 (refer to Figure 10). For the second source (+5V), remove the jumper on JP1 and connect this source to the top side (pin 1, 3, 5, 7, or 9 of JP1).

The supply voltage must be between 1.8 and 3.3 V. AVDD input must not be used, and SB1 must be ON during this measurement.

Figure 10. Current measurement with STLINK-V3PWR



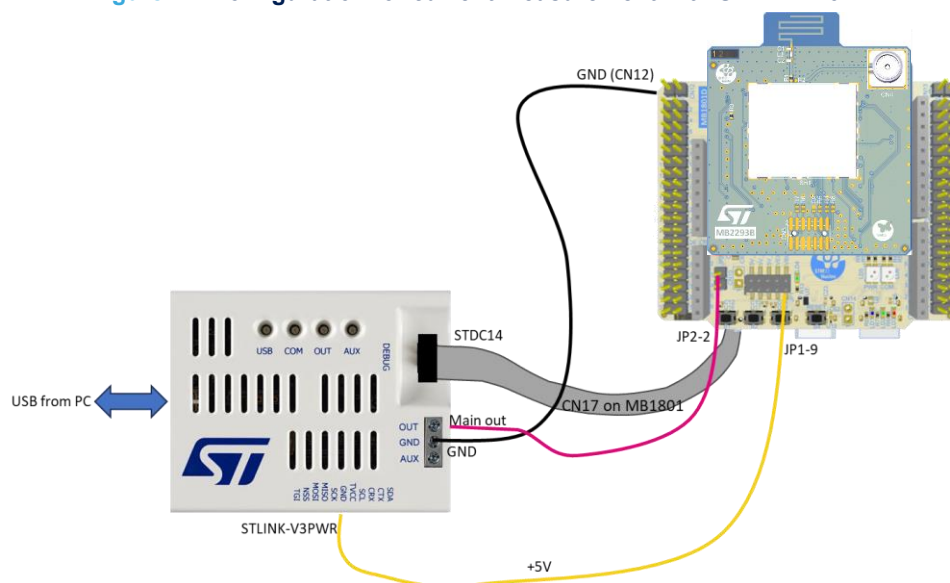
The details above concern the supply of the board by STLINK-V3PWR. Now, the debug feature of these tools also needs some modification.

By default, MB2293 is delivered without the possibility of debugging by an external tool. Nevertheless, it is possible to solder an MIPI-10 connector on the CN3 footprint.

For more details, refer to [Section 7.13: MIPI-10 interface and pinout](#)

Caution: By default, this 10-pin MIPI connector (CN3) is not assembled because it prohibits the use of an ARDUINO® shield. The height of the connector is not compatible with the plug of the ARDUINO® shield. Moreover, it is always possible to plug an ST morpho shield on the bottom side of MB1801.

Figure 11. Configuration for current measurement with STLINK-V3PWR



Caution: No VCP is available on the MIPI10 connector (CN17). If you need VCP1, replace connector CN17 with a 14-pin STDC14 connector.

After connection, download STM32CubeMonitor-Power (STM32CubeMonPwr) from the www.st.com website and install it. This software allows the user to carry out dynamic current measurements with ease. Figure 12 shows an example of a current measurement (firmware: Heart Rate from the STM32CubeWBA firmware package).

Figure 12. Example of current measurement with an external STLINK-V3PWR

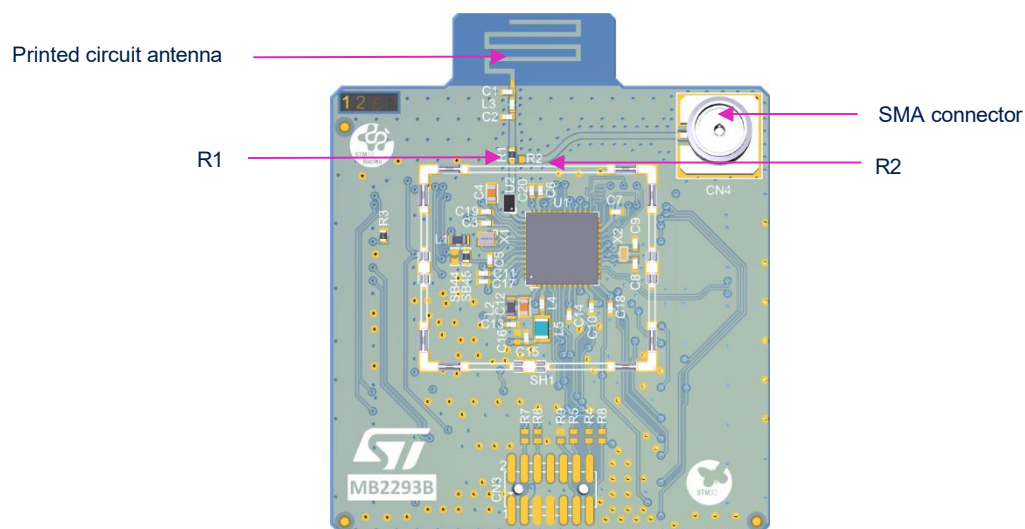


For more details on using STLINK-V3PWR, a dedicated page is available on the www.st.com website.

7.2 Radio output configuration

- By default, the board is configured with R1 ON and R2 OFF to use the PCB antenna.
- The configuration to use the SMA antenna is R1 OFF and R2 ON. The user must assemble the SMA connector which is not present by default.

Figure 13. Antenna elements on MCU RF board



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7.3 Clock sources

7.3.1 HSE clock references

The accuracy of the high-speed clock (HSE) of the MCU RF board is committed to a 32 MHz crystal oscillator. The HSE oscillator is trimmed during board manufacturing.

7.3.2 LSE clock references

The accuracy of the low-speed clock (LSE) of the MCU RF board is committed to a 32.768 kHz crystal oscillator.

7.4 Reset sources

The reset signal of NUCLEO-WBA25CE1 is active LOW. The internal PU forces the RST signal to a high level. The sources of reset are:

- Reset push-button (B4)
- Embedded STLINK-V3EC
- ARDUINO® connector (CN5 pin 3), reset from the ARDUINO® board
- ST morpho connector (CN3 pin 14)

7.5 Embedded STLINK-V3EC

The STLINK-V3EC programming and debugging tool is integrated into NUCLEO-WBA25CE1.

Features supported on STLINK-V3EC:

- USB 2.0 full-speed interface
- Probe firmware update through USB
- JTAG communication support up to 21 MHz
- SWD and SWV communication support up to 24 MHz
- 3.0 to 3.6 V application voltage support and 5 V tolerant inputs
- Virtual COM port (VCP) up to 16 Mbps
- Optional drag-and-drop flash memory programming binary files
- Multipath bridge USB to SPI/UART/I²C/GPIOs
- Status COM LED (LD5) which blinks during communication with the PC (red by default)
- Fault LED (LD6) alerting on USB overcurrent (green, orange, or red)
- USB-C® overvoltage protection (U10) with current limitation

For detailed information about the STLINK-V3EC capabilities such as LED management, drivers, and firmware, refer to the technical note *Overview of ST-LINK derivatives* (TN1235) at www.st.com.

For information about the debugging and programming features of STLINK-V3EC, refer to the user manual *STLINK-V3SET debugger/programmer for STM8 and STM32* (UM2448) at www.st.com.

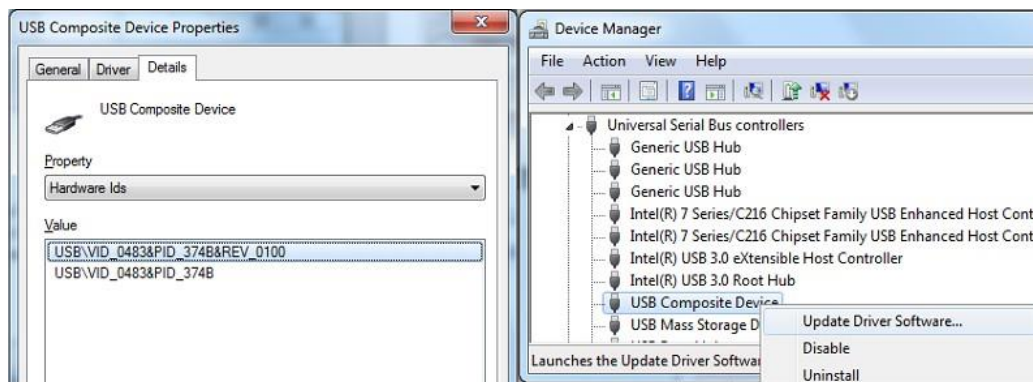
7.5.1 Drivers

STLINK-V3EC requires a dedicated USB driver, which, for Windows 7® and Windows 8® is available from www.st.com. For Windows 10®, it is not necessary to install the driver. ST-LINK is automatically identified.

In case the NUCLEO-WBA25CE1 board is connected to the PC before the driver is installed, some board interfaces might be declared as *Unknown* in the PC device manager. In this case, the user must install the dedicated driver files and update the driver of the connected device from the device manager, as shown in [Figure 14. USB composite device](#).

Note: *It is preferable to use the USB Composite Device to handle a full recovery.*

Figure 14. USB composite device



7.5.2 STLINK-V3EC firmware upgrade

STLINK-V3EC embeds a firmware mechanism (STSW-LINK007) for the in-place upgrade through the USB port. The firmware might evolve during the lifetime of the STLINK-V3EC product (for example new functionalities, bug fixes, support for new microcontroller families). Visit the www.st.com website before starting to use the NUCLEO-WBA25CE1 board, then periodically to stay updated with the latest firmware version.

For detailed information on the ST-LINK USB drivers, refer to the technical note *Overview of ST-LINK derivatives* (TN1235) at www.st.com.

7.5.3 STLINK-V3EC USB connector (CN15)

The main function of this connector is the access to STLINK-V3EC embedded on the NUCLEO-WBA25CE1 for the debugging as explained above. It allows supplying the board (refer to [Section 7.1: Power supply](#)). The connector is a standard USB Type-C® connector.

Table 5. STLINK-V3EC USB Type-C® connector (CN15)

Pin	Pin name	Signal name	Function
A4, A9, B4, B9	VBUS	VBUS_STLK	VBUS power
A7, B7	DM	STLK_USB_N	DM
A6, B6	DP	STLK_USB_P	DP
A5	CC1	-	Configuration Channel-
B5	CC2	-	Configuration Channel-
A1, A12, B1, B12	GND	GND	GND

7.5.4 Virtual COM port USART1 (VCP1)

STLINK-V3EC offers a USB Virtual COM port bridge. This feature allows access to the USART1 of NUCLEO-WBA25CE1 by the USB ST-LINK connector. By default, this USART1 interface of NUCLEO-WBA25CE1 is connected to the VCP1 of the STLINK-V3EC MCU (STM32F723IE).

Access is possible on the CN3 connector of the mezzanine board (MB1801). Both signals Tx and Rx are available, and two solder bridges allow disconnecting them of the UART coming from the SoC. By default, VCP1 is connected to the USART1 of STM32WBA25CE.

Table 6. VCP1 interface pinout description

STM32WBA25CE (MB2293)	CN3 (MB1801)	STM32F723IE (MB1801)
USART1 Rx (PA12/pin 28)	Pin 35 (GPIO23) (SB5 ON)	STLK_VCP_TX: PG14/pin A7
USART1 Tx (PA6/pin 7) (SB21 ON)	Pin 37 (GPIO24) (SB3 ON)	STLK_VCP_RX: PG9/pin C10

7.5.5 Virtual COM port USART (VCP2)

It is possible to replace the mass storage interface with a second Virtual COM port. It is also necessary to do a firmware upgrade through STM32CubeProgrammer (refer to the technical note *Overview of ST-LINK derivatives* (TN1235) at www.st.com).

The access is possible on the CN3 and CN4 connectors of the mezzanine board (MB1801). All signals (Tx, Rx, RTS, and CTS) are available. SB4 needs to be connected to use PA15 as RTS.

Table 7. VCP2 interface pinout description

STM32WBA25CE (MB2293)	CN3 and CN4 (MB1801)	STM32F723IE (MB1801)
LPUART1_RX (PA1) SB10 ON and SB4 OFF by default	CN4/pin 37 (GPIO55) (SB7 ON)	T_VCP2_TX : PC10/pin B14
LPUART1_TX (PH3) SB8 ON and SB43 OFF by default	CN4/pin 35 (GPIO54) (SB8 ON)	T_VCP2_RX : PB11/pin R13
LPUART1_CTS(PB15) SB16 OFF and SB38 OFF by default	CN4/pin26 (GPIO46) (SB25 ON)	T_VCP2_RTS : PD12/pin N13
LPUART1_RTS (PA10) SB35 OFF by default	CN3/pin2 (GPIO2) (SB23 ON)	T_VCP2_CTS : PD11/pin N14

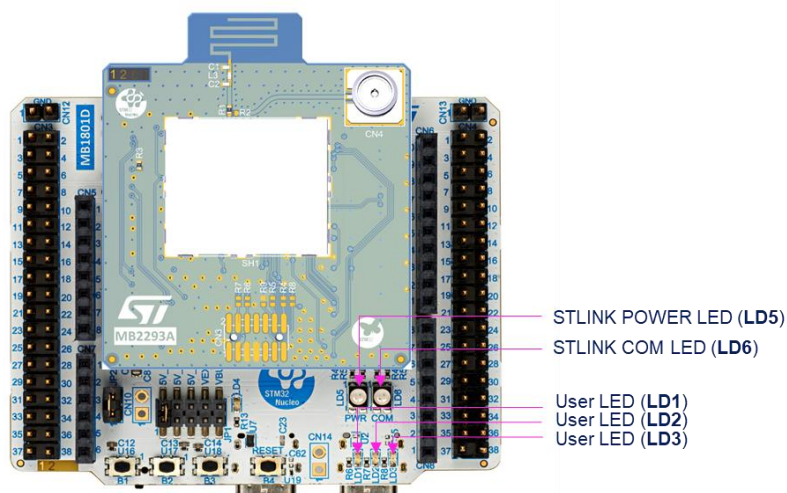
7.5.6 Level shifter

NUCLEO-WBA25CE1 features a system to supply STM32WBA25CE with a voltage different from the ST-LINK one. 3V3 sources always supply ST-LINK. By default, the same voltage value supplies STM32WBA25CE and ST-LINK, but it is possible to supply the SoC with another value. It accepts voltage between 1.8 and 3.3 V trust to a specific component (level shifter). This level shifter ensures the voltage conversion between ST-LINK and the SoC. It drives SWD and UART signals connected to the VCP1 or VCP2 on the ST-LINK.

7.6 LEDs

Four LEDs on the top side of the Nucleo board help the user during the application development.

Figure 15. LEDs location



- LD1: This blue LED is available for user application.
- LD2: This green LED is available for user application.
- LD3: This red LED is available for user application.
- LD4: This LED turns green when a 5V source is available (to select the 5V source, refer to [Section 7.1.3: 5 V power supply](#)).
- LD5: This LED gives information about the STLINK-V3EC target power.
- LD6: This LED blinks during communication with the PC.

For detailed information about the STLINK-V3EC LEDs, refer to the technical note *Overview of ST-LINK derivatives* (TN1235) at www.st.com.

Table 8. I/O configuration for the physical user interface

Name	I/O
User LED (LD1)	PA7
User LED (LD2)	PB12
User LED (LD3)	PB15

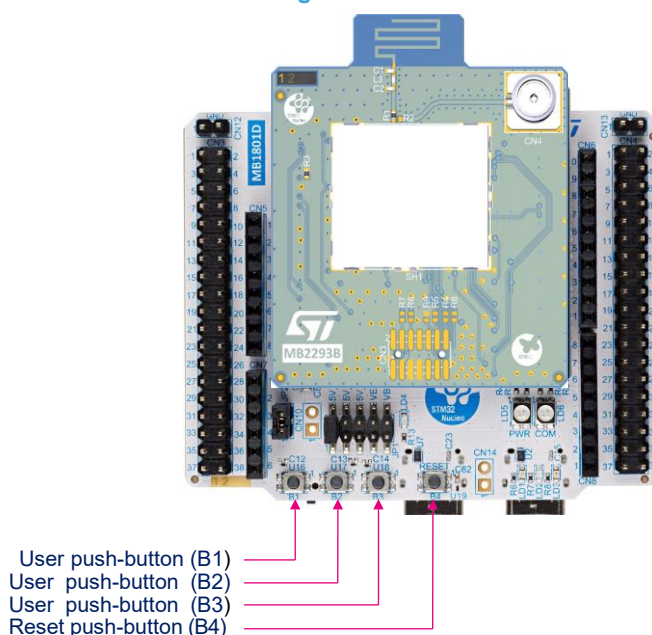
7.7 Push-buttons

7.7.1 Description

NUCLEO-WBA25CE1 provides two types of buttons:

- USER1 push-button (B1)
- USER2 push-button (B2)
- USER2 push-button (B3)
- Reset push-button (B4), used to reset the Nucleo board

Figure 16. Push-button location



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7.7.2 Reset push-button

B4 is dedicated to the hardware reset of the Nucleo board.

7.7.3 User push-buttons

There are three push buttons available for the user application. They are connected to PA1, PA2 and PC13. It is possible to use with GPIO reading or to wake up the device.

Note that PC13 is also connected to ARDUINO® and ST morpho connectors as GPIO, depending on the use case that can generate conflict with B2. In this case, it is possible to remove the connection of B2 (SB4 OFF).

Table 9. I/O configuration for the physical user interface

Name	I/O	Wake-Up available
USER1 push-button (B1)	PA1	WKUP3
USER2 push-button (B2)	PC13	WKUP2
USER3 push-button (B3)	PA2	WKUP4

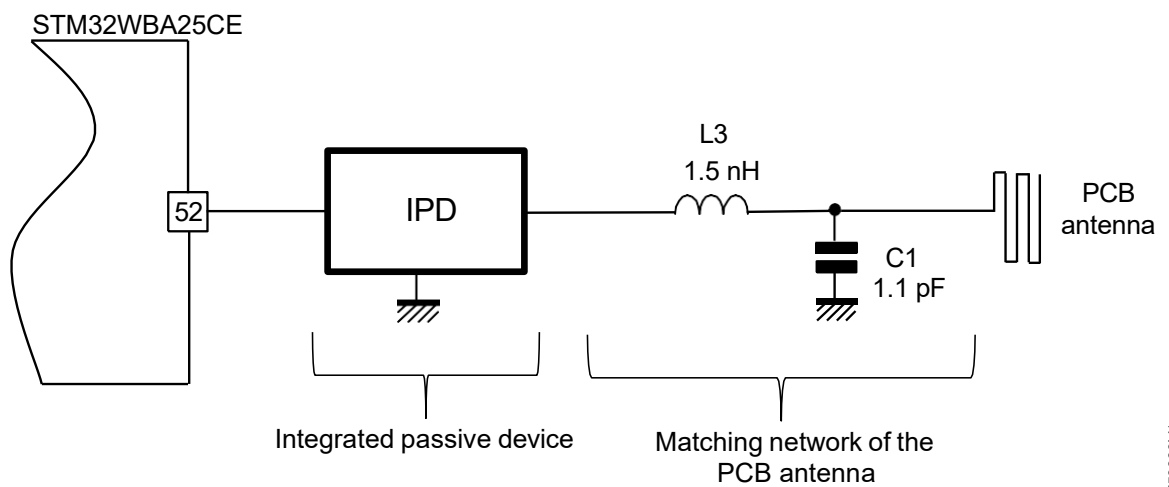
7.8 RF I/O stage

Due to FCC/ISED constraints, the antenna cannot be removable. So, the board is proposed by default with a PCB antenna. This antenna is described in the application note *Guidelines for meander design using low-cost PCB antennae with 2.4 GHz radio for STM32WB/WB0 MCUs (AN5129)* available at www.st.com. Between the STM32WBA25CE and the antenna, there is an integrated passive device (IPD). This IPD considerably reduces harmonics and adapts the output to 50 Ω . This makes it easy to pass certification requirements, such as FCC, ISED, RED, and MIC. At the IPD output, there are two passive components for antenna matching.

The harmonics are drastically reduced with this IPD.

The antenna matching network is built with two components L3 and C1. This guarantees a comfortable margin in all cases. The study considers the drift of the components (accuracy and temperature), the drift due to the PCB, and the variation of STM32WBA25CE. Of course, depending on the component manufacturer and the specification of the PCB, these component values can change after optimization.

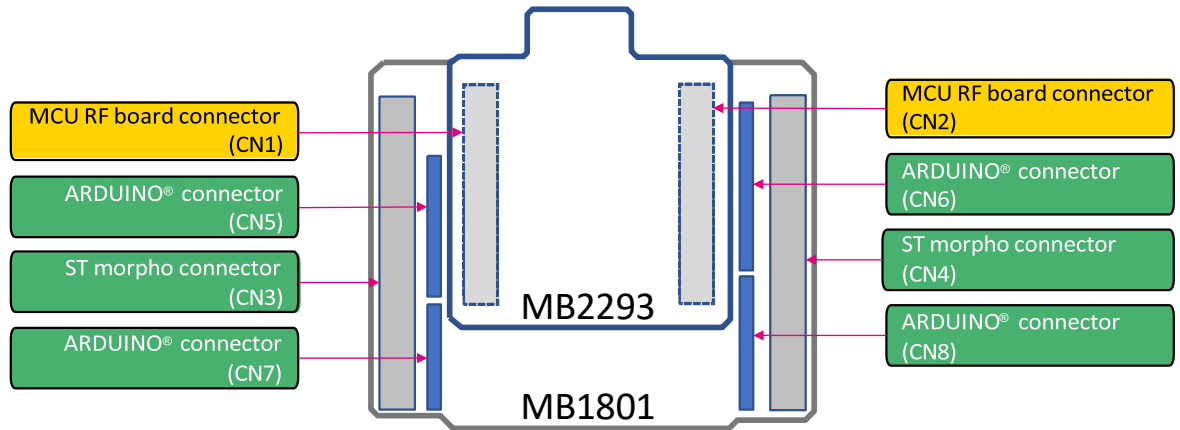
Figure 17. RF I/O stage



DT59369V1

7.9 Connector naming

Figure 18. Connector locations and namings



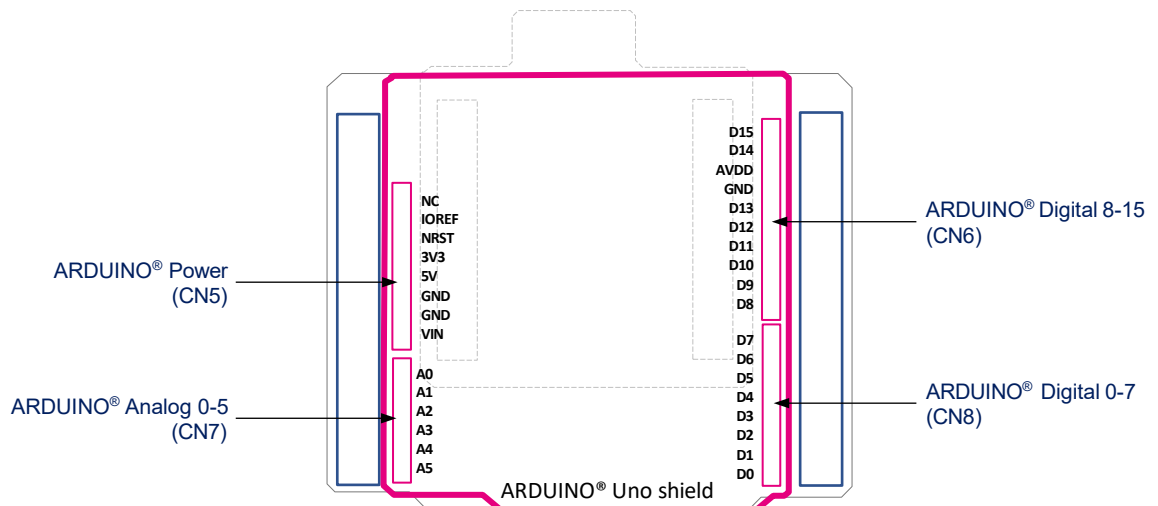
DT59629V1

7.10 ARDUINO® interface and pinout

7.10.1 Description

On the bottom side of the board, there is an ARDUINO® Uno V3 extension socket. It is built around four standard connectors (CN5, CN6, CN7, and CN8). Most shields designed for ARDUINO® can fit with the Discovery kits to offer flexibility in small form factor applications.

Figure 19. ARDUINO® Uno connectors and ARDUINO® shield location



DT59630V1

7.10.2 Operating voltage

The ARDUINO® Uno V3 connectors support 5 V, 3.3 V, and VDD for I/O compatibility.

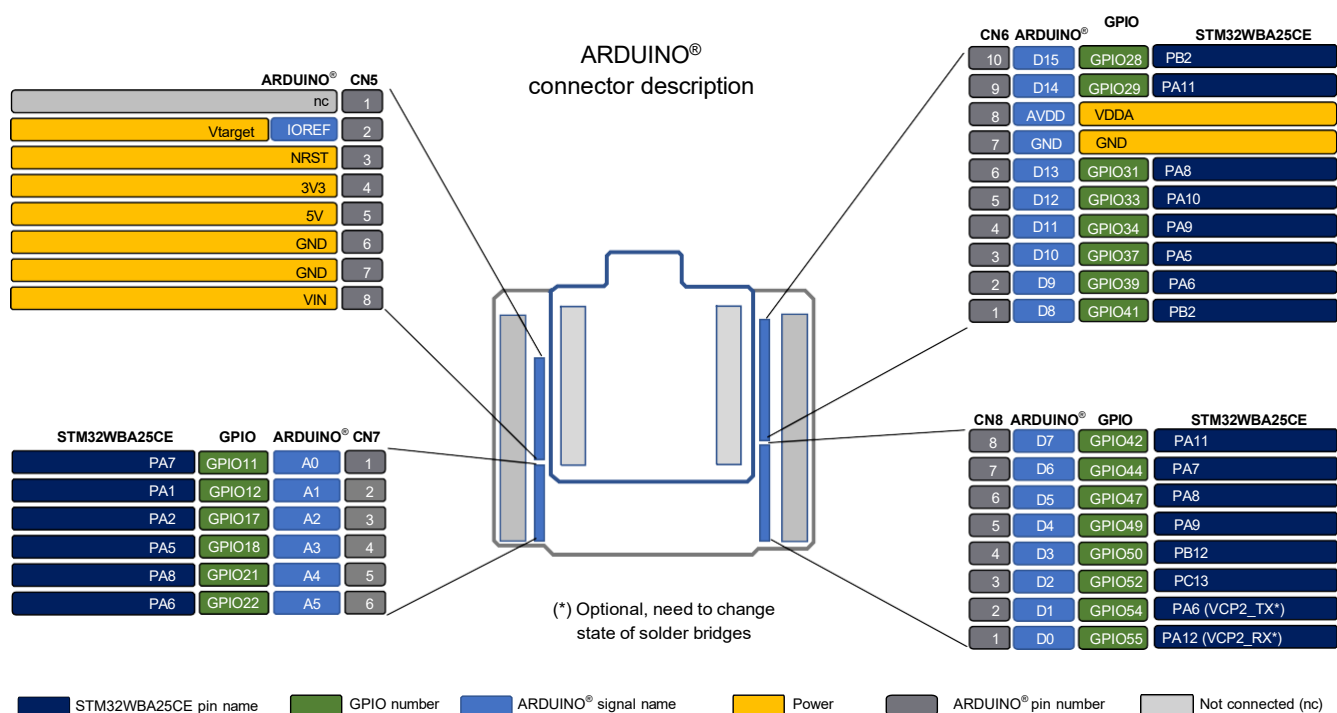
Caution: Do not supply 3.3 or 5 V from the ARDUINO® shield. Supplying 3.3 or 5 V from the ARDUINO® shield might damage the Nucleo board.

The Nucleo board can be supplied by the ARDUINO® connector. A dedicated pin is available. VIN allows supplying the board directly. To use this feature, refer to [Section 7.1.2: 7 to 12 V power supply](#).

7.10.3 ARDUINO® pinout

Figure 18 shows the position of the ARDUINO® shield when plugged into NUCLEO-WBA25CE1. The pinout shown in Figure 20 corresponds to standard ARDUINO® naming. To see the correspondence with the STM32, refer to Table 10.

Figure 20. ARDUINO® connector pinout



DT59631V1

Table 10. Pinout of the ARDUINO® connectors

Left connectors					Right connectors				
Connector	Pin number	Pin name	MCU pin	Function	Function	MCU pin	Pin name	Pin number	Connector
CN5	1	NC	-	NC (reserved for tests)	I2C1_SCL/I2C3_SCL	PB2	D15	10	CN6
	2	3V3 (IOREF)	-	IOREF	I2C1_SDA/I2C3_SDA	PA11	D14	9	
	3	NRST	NRST	NRST	VDDA	-	AVDD	8	
		3V3	-	3V3	GND	-	GND	7	
	5	5V	-	5V	SPI3_SCK	PA8	D13	6	
	6	GND	-	GND	SPI3_MISO	PA10	D12	5	
	7	GND	-	GND	SPI3_MOSI	PA9	D11	4	
	8	VIN	-	External supply input (+12Vmax)	SPI3_NSS/TIM2_CH1	PA5	D10	3	
CN7	1	A0	PA7	ADC4_IN2	GPIO/TIM2_CH4	PA6	D9	2	CN8
	2	A1	PA1	ADC4_IN8	GPIO	PB2	D8	1	
	3	A2	PA2	ADC4_IN7	GPIO	PA11	D7	8	
	4	A3	PA5	ADC4_IN4	GPIO/TIM2_CH3	PA7	D6	7	
	5	A4	PA8	ADC4_IN1	GPIO/TIM2_CH2	PA8	D5	6	
	6	A5	PA6	ADC4_IN3	GPIO	PA9	D4	5	
					GPIO/TIM2_CH1	PB12	D3	4	
					GPIO	PC13	D2	3	
					USART1_TX ⁽¹⁾	PA6/PH3	D1	2	
					USART1_RX ⁽¹⁾	PA12 / PA1	D0	1	

1. Optional, need to change the state of solder bridges.

7.11 ST morpho interface and pinout

7.11.1 Description

The ST morpho connectors (CN3 and CN4) are male pin headers accessible on both sides of the board. All signals and power pins of the MCU are available on the ST morpho connectors. An oscilloscope, logical analyzer, or voltmeter can also probe these connectors.

7.11.2 ST morpho pinout

Figure 21. ST morpho pinout

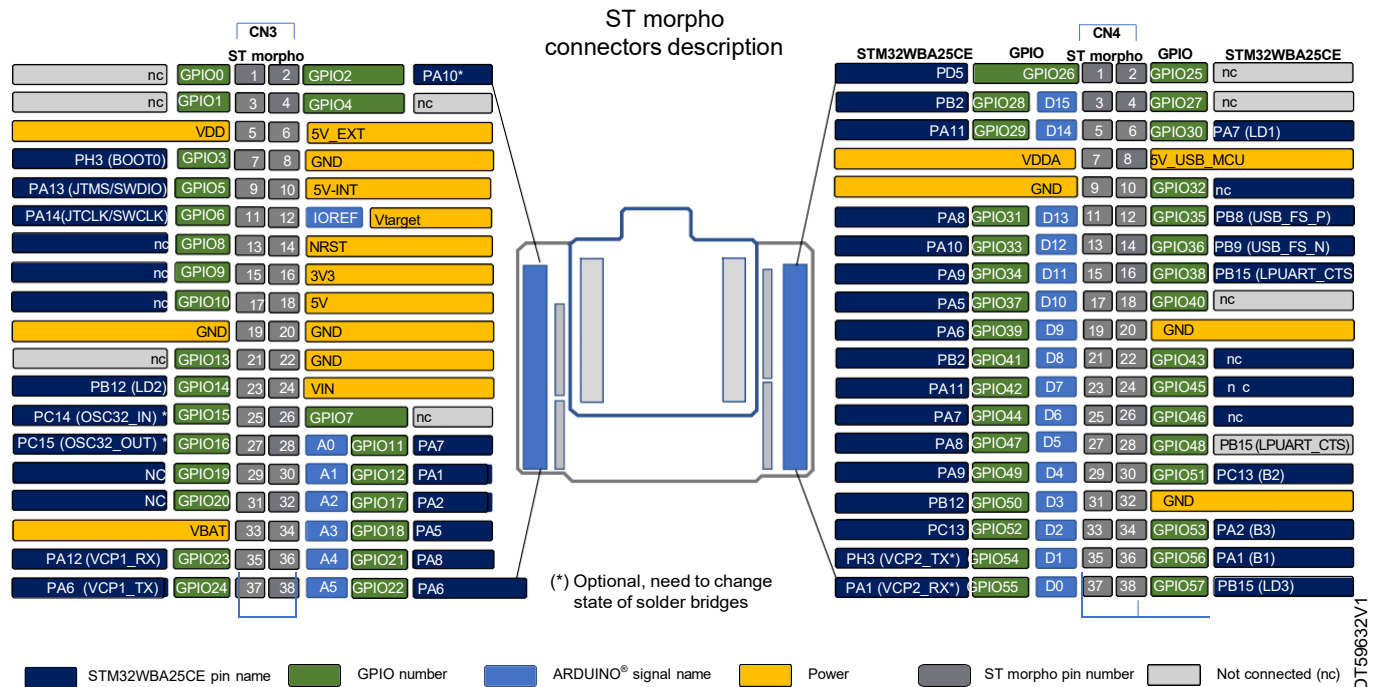


Table 11. ST morpho pinout

CN3				CN4			
Pin number	STM32WBA25CE pin name	Pin number	STM32WBA25CE pin name	Pin number	STM32WBA25CE pin name	Pin number	STM32WBA25CE pin name
1	NC	2	PA10	1	NC	2	NC
3	NC	4	NC	3	PB2	4	NC
5	VDD	6	5V_EXT	5	PA11	6	PA7
7	BOOT0	8	GND	7	VDDA	8	5V_USB_MCU
9	PA13	10	NC	9	GND	10	NC
11	PA14	12	IOREF	11	PA8	12	PB8 (USB_FS_P)
13	NC	14	NRST	13	PA10	14	PB9 (USB_FS_N)
15	NC	16	3V3	15	PA9	16	PB15
17	NC	18	5V	17	PA5	18	NC
19	GND	20	GND	19	PA6	20	GND
21	NC	22	GND	21	PB2	22	NC
23	PC4	24	VIN	23	PA11	24	NC
25	PC14	26	NC	25	PA7	26	PB15
27	PC15	28	PA7NC	27	PA8	28	NC
29	NC	30	PA1	29	PA9	30	PC13
31	NC	32	PA2	31	PB12	32	GND
33	VBAT	34	PA5	33	PC13	34	PA2
35	PA12	36	PA8	35	PH3 (VCP2_TX) ⁽¹⁾	36	PA1
37	PA6	38	PA6	37	PA1 (VCP2_RX) ⁽¹⁾	38	PB15

1. Optional, need to change the state of solder bridges.

7.12 MCU RF board interface and pinout

7.12.1 Description

The MCU RF board connectors (CN1 and CN2) are accessible on the top side of the board. They are used to plug the MCU RF board into the mezzanine board.

7.12.2 MCU RF board pinout

Figure 22. MCU RF board connector pinout

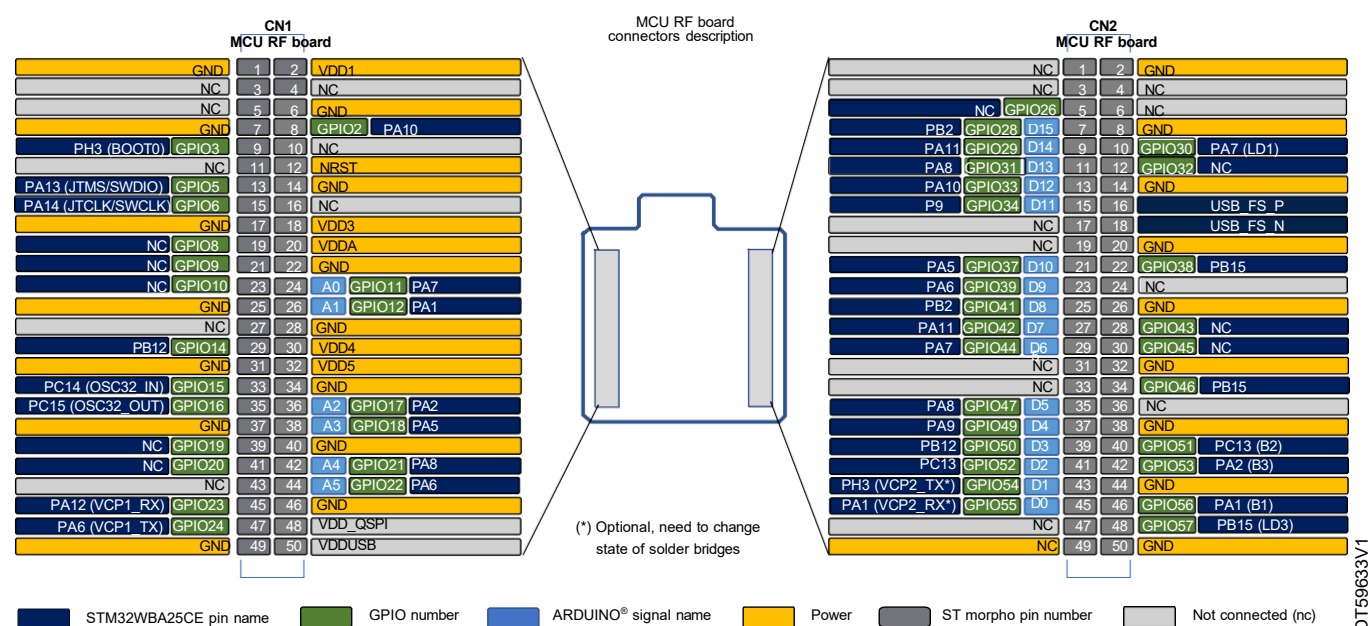


Table 12. MCU RF board connector pinout

CN1				CN2			
Pin number	STM32WBA25CE pin name	Pin number	STM32WBA25CE pin name	Pin number	STM32WBA25CE pin name	Pin number	STM32WBA25CE pin name
1	GND	2	VDD1	1	NC	2	GND
3	NC	4	NC	3	NC	4	NC
5	NC	6	GND	5	NC	6	NC
7	GND	8	PA10	7	PB2	8	GND
9	BOOT0	10	NC	9	PA11	10	PA7
11	NC	12	NRST	11	PA8	12	NC
13	PA13	14	GND	13	PA10	14	GND
15	PA14	16	NC	15	PA9	16	PB8
17	GND	18	VDD3	17	NC	18	PB9
19	NC	20	VDDA	19	NC	20	GND
21	NC	22	GND	21	PA5	22	PB15
23	NC	24	PA7	23	PA6	24	NC
25	GND	26	PA1	25	PB2	26	GND
27	NC	28	GND	27	PA11	28	NC
29	PB12	30	VDD4	29	PA7	30	NC
31	GND	32	VDD5	31	NC	32	GND
33	PC14	34	GND	33	NC	34	PB15
35	PC15	36	PA2	35	PA8	36	NC
37	GND	38	PA5	37	PA9	38	GND
39	NC	40	GND	39	PB12	40	PC13
41	NC	42	PA8	41	PC13	42	PA2
43	NC	44	PA6	43	PH3	44	GND
45	PA12	46	GND	45	PA1	46	PA1
47	PA6	48	VDD_QSPI	47	NC	48	PB15
49	GND	50	VDDUSB	49	NC	50	GND

1. Optional, need to change the state of solder bridges.

7.13 MIPI10 connector

7.13.1 Description

On the MCU RF board, there is a footprint for direct debugging (SWD). The footprint is compatible with MIPI10 connector (CN3). By default, CN3 is not assembled.

When using CN3, the resistors R5, R6, R7, R8, and R9 must be connected.

Table 13. Pinout of the MIPI10/STDC14 connector (CN3 of the MCU RF board)

STDC14 pin #	MIPI10 pin #	Pin description	Type
1	-	Reserved ⁽¹⁾	-
2	-	Reserved ⁽¹⁾	-
3	1	T_VCC ⁽²⁾	I
4	2	T_JTMS/T_SWDIO	I/O
5	3	GND	S
6	4	T_JCLK/T_SWCLK	O
7	5	GND	S
8	-	-	I
9	7	T_JCLK	O
10	-	-	O
11	9	GNDDetect	O
12	10	T_NRST	O
13	-	T_VCP_RX	O
14	-	T_VCP_TX	I

7.14 MIPI10 connector

On the mezzanine board, there is also a connector (CN17) for direct debugging. This connector is compatible with MIPI10 and it is possible to change the connector or connect the missing signals to have STDC14 full signals. Nevertheless, it is necessary to put the onboard ST-LINK in reset mode by mounting JP3.

Table 14. Pinout of the MIPI10/STDC14 connector (CN3 of the MCU RF board)

STDC14 pin #	MIPI10 pin #	Pin description	Type
1	-	Reserved ⁽¹⁾	-
2	-	Reserved ⁽¹⁾	-
3	1	T_VCC ⁽²⁾	I
4	2	T_JTMS/T_SWDIO	I/O
5	3	GND	S
6	4	T_JCLK/T_SWCLK	O
7	5	GND	S
8	6	T_JTDO/T_SWO ⁽³⁾	I
9	7	T_JCLK	O
10	8	T_JTDI/NC ⁽⁴⁾	O
11	9	GNDDetect	O
12	10	T_NRST	O
13	-	T_VCP_RX	O
14	-	T_VCP_TX	I

1. Do not connect to the target.
2. Input for STLINK-V3EC
3. SWO is optional, required only for Serial Wire Viewer (SWV)
4. NC means it is not required for the SWD connection.

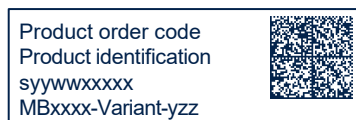
8 NUCLEO-WBA25CE1 product information

8.1 Product marking

The product and each board composing the product are identified with one or several stickers. The stickers, located on the top or bottom side of each PCB, provide product information:

- Main board featuring the target device: product order code, product identification, serial number, and board reference with revision.

Single-sticker example:



Dual-sticker example:



- Other boards if any: board reference with revision and serial number.

Examples:



On the main board sticker, the first line provides the product order code, and the second line the product identification.

On all board stickers, the line formatted as “MBxxxx-Variant-yyz” shows the board reference “MBxxxx”, the mounting variant “Variant” when several exist (optional), the PCB revision “y”, and the assembly revision “zz”, for example B01. The other line shows the board serial number used for traceability.

Products and parts labeled as “ES” or “E” are not yet qualified or feature devices that are not yet qualified. STMicroelectronics disclaims any responsibility for consequences arising from their use. Under no circumstances will STMicroelectronics be liable for the customer's use of these engineering samples. Before deciding to use these engineering samples for qualification activities, contact STMicroelectronics' quality department.

“ES” or “E” marking examples of location:

- On the targeted STM32 that is soldered on the board (for an illustration of STM32 marking, refer to the STM32 datasheet *Package information* paragraph at the www.st.com website).
- Next to the ordering part number of the evaluation tool that is stuck, or silk-screen printed on the board.

Some boards feature a specific STM32 device version, which allows the operation of any bundled commercial stack/library available. This STM32 device shows a “U” marking option at the end of the standard part number and is not available for sales.

To use the same commercial stack in their applications, the developers might need to purchase a part number specific to this stack/library. The price of those part numbers includes the stack/library royalties.

8.2 NUCLEO-WBA25CE1 product history

Table 15. Product history

Order code	Product identification	Product details	Product change description	Product limitations
NUCLEO-WBA25CE1	ENUWBA25CE1\$CR2	MCU: STM32WBA25CEU7 silicon revision "TBC"	Initial revision	No limitation
		MCU errata sheet: STM32WBA2xxx device errata (TBC)		
		Boards: - MB1801-USB-D01 (mezzanine board) - MB2293-WBA2-B05 (MCU RF board)		

8.3 Board revision history

Table 16. Board revision history

Board reference	Board variant and revision	Board change description	Board limitations
MB1801 (mezzanine board)	USB-D01	Initial revision	No limitation
MB2293 (MCU RF board)	WBA2-B05	Initial revision	No limitation

9 Federal Communications Commission (FCC) and ISED Canada Compliance Statements

9.1 FCC Compliance Statement

Identification of products: NUCLEO-WBA25CE1
FCC ID: YCP-MB229300

Radio Frequency (RF) Exposure Compliance of Radio communication: To satisfy FCC RF Exposure requirements, a separation distance of 20cm or more should be maintained between the antenna of this device and persons during operation. To ensure compliance, operation at a closer distance than this is not recommended. This transmitter must not be co-located or operating in conjunction with any other antenna or transmitter.

Part 15.19

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Part 15.21

Any changes or modifications to this equipment not expressly approved by STMicroelectronics may cause harmful interference and void the user's authority to operate this equipment. Part 15.105 This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates uses and can radiate radio frequency energy and, if not installed and used in accordance with the instruction, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception which can be determined by turning the equipment off and on, the user is encouraged to try to correct interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

Responsible party (in the USA)

Francesco Doddo
STMicroelectronics, Inc.
200 Summit Drive | Suite 405 | Burlington, MA 01803
USA
Telephone: +1 781-472-9634

9.2 ISED Compliance Statement

Identification of products: NUCLEO-WBA25CE1
IC: 8976A-MB229300

Identification du produit : NUCLEO-WBA25CE1
Contient sous-ensemble certifié IC : 8976A-MB229300

Compliance Statement

Notice: This device complies with ISED Canada licence-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Déclaration de conformité

Avis: Le présent appareil est conforme aux CNR d'ISDE Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes : (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

RF exposure statement

This device complies with ISDE radiation exposure limits set forth for general population. This device must be installed to provide a separation distance of at least 20cm from all persons and must not be co-located or operating in conjunction with any other antenna or transmitter. Le présent appareil est conforme aux niveaux limites d'exigences d'exposition RF aux personnes définies par ISDE. L'appareil doit être installé afin d'offrir une distance de séparation d'au moins 20cm avec les personnes et ne doit pas être installé à proximité ou être utilisé en conjonction avec une autre antenne ou un autre émetteur.

10 RED Compliance Statement

Déclaration de conformité CE simplifiée

STMicroelectronics déclare que l'équipement radioélectrique du type "NUCLEO-WBA25CE1" est conforme à la directive 2014/53/UE.

Bande de fréquence utilisée en transmission et puissance maximale rayonnée dans cette bande :

- Bande de fréquence : 2400-2483.5 MHz (Bluetooth®)
- Puissance maximale : 8 mW p.i.r.e

Simplified EC compliance statement

Hereby, STMicroelectronics declares that the radio equipment type "NUCLEO-WBA25CE1" is in compliance with Directive 2014/53/EU.

Frequency range used in transmission and maximal radiated power in this range:

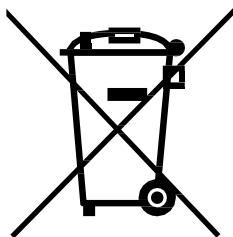
- Frequency range: 2400-2483.5 MHz (Bluetooth®)
- Maximal power: 8 mW e.i.r.p



11 Product disposal

Disposal of this product: WEEE (Waste Electrical and Electronic Equipment)

(Applicable in Europe)



This symbol on the product, accessories, or accompanying documents indicates that the product and its electronic accessories should not be disposed of with household waste at the end of their working life.

To prevent possible harm to the environment and human health from uncontrolled waste disposal, please separate these items from other type of waste and recycle them responsibly to the designated collection point to promote the sustainable reuse of material resources.

Household users:

You should contact either the retailer where you buy the product or your local authority for further details of your nearest designated collection point.

Business users:

You should contact your dealer or supplier for further information.

Revision history

Table 17. Document revision history

Date	Revision	Changes
11-Dec-2025	1	Initial release.

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